

# N-Channel Enhancement Mode MOSFET

## 1. Product Information

### 1.1 Features

- Advanced trench cell design
- Low Thermal Resistance
- MSL1
- Tj max 175°C

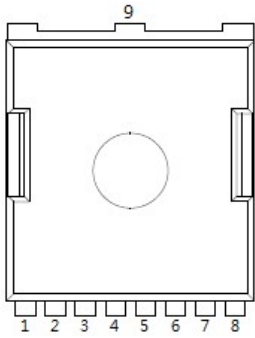
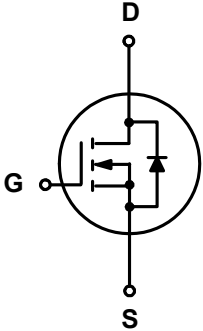
### 1.2 Applications

- Motor drivers
- DC - DC Converter

### 1.3 Quick reference

- BV ≥ 120 V
- R<sub>DS(ON)</sub> ≤ 5.5 mΩ @ V<sub>GS</sub> = 10 V
- P<sub>tot</sub> ≅ 375 W
- R<sub>DS(ON)</sub> ≤ 7.5 mΩ @ V<sub>GS</sub> = 6 V
- I<sub>D</sub> ≅ 250 A

## 2. Pin Description

Pin	Description	Simplified Outline	Symbol
1	Gate(G)	 <p style="text-align: center;">Top View TOLL</p>	
2,3,4,5,6,7,8	Source(S)		
9	Drain(D)		

### 3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	Drain-Source Voltage	T <sub>C</sub> = 25 °C	120	-	V
V <sub>GS</sub>	Gate-Source Voltage	T <sub>C</sub> = 25 °C	-	± 20	V
I <sub>D</sub> *	Drain Current ( DC )	T <sub>C</sub> = 25 °C, V <sub>GS</sub> = 10 V	-	250	A
		T <sub>C</sub> = 100 °C, V <sub>GS</sub> = 10 V	-	177	A
I <sub>DM</sub> <sup>*,**</sup>	Drain Current ( Pulsed )	T <sub>C</sub> = 25 °C, V <sub>GS</sub> = 10 V	-	396	A
P <sub>tot</sub> *	Total Power Dissipation	T <sub>C</sub> = 25 °C	-	375	W
T <sub>stg</sub>	Storage Temperature		- 55	150	°C
T <sub>J</sub>	Junction Temperature		-	150	°C
I <sub>S</sub>	Diode Forward Current	T <sub>C</sub> = 25 °C	-	250	A
E <sub>AS</sub> *	Single Pulsed Avalanche Energy	V <sub>DD</sub> = 50 V , L= 1.0 mH	-	922	mJ
R <sub>θJA</sub> *	Thermal Resistance- Junction to Ambient		-	40	°C / W
R <sub>θJC</sub> *	Thermal Resistance- Junction to Case		-	0.45	

Notes :

- \* Surface Mounted on 1 in<sup>2</sup> pad area, t ≤ 10 sec
- \*\* Pulse width ≤ 300 μs, duty cycle ≤ 2 %
- \*\*\* Thermal resistance, junction - case, bottom with thermal pad

### 4. Marking Information

Product Name	Marking
UP0512T	

### 5. Ordering Code

Product Name	Package	Reel Size	Tape width	Quantity	Note
UP0512T	TOLL-8L			2000	

Note: UOE defines “ Green ” as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

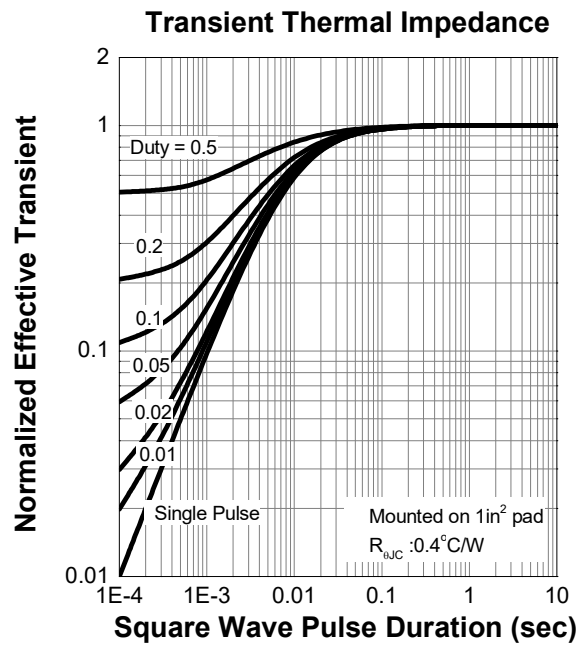
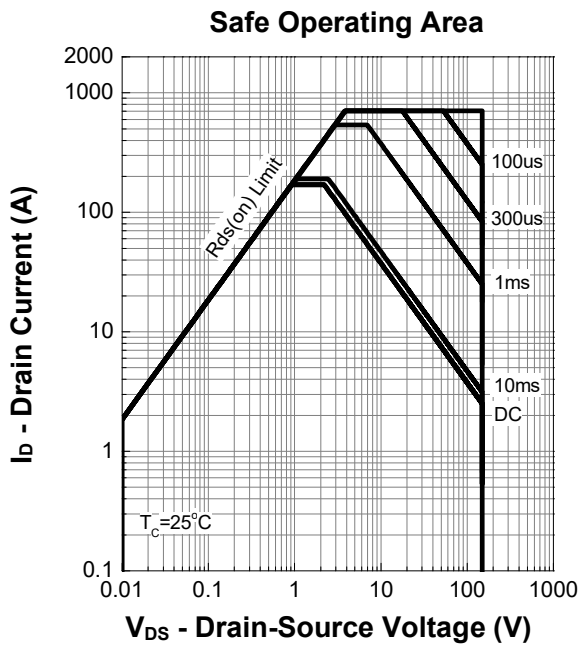
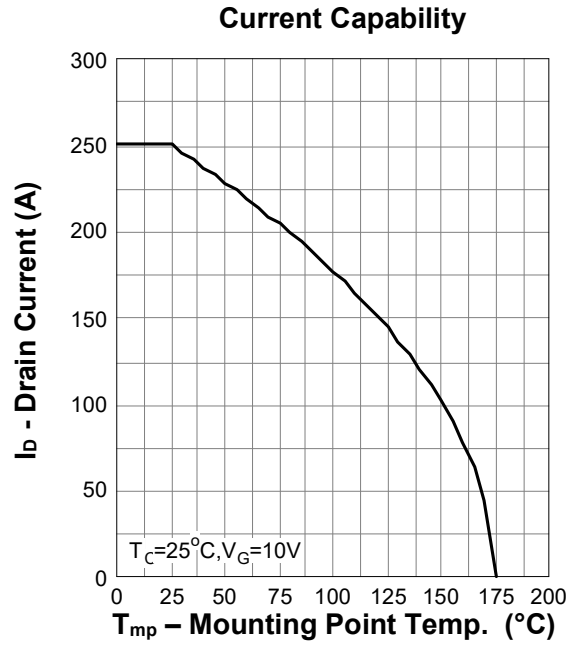
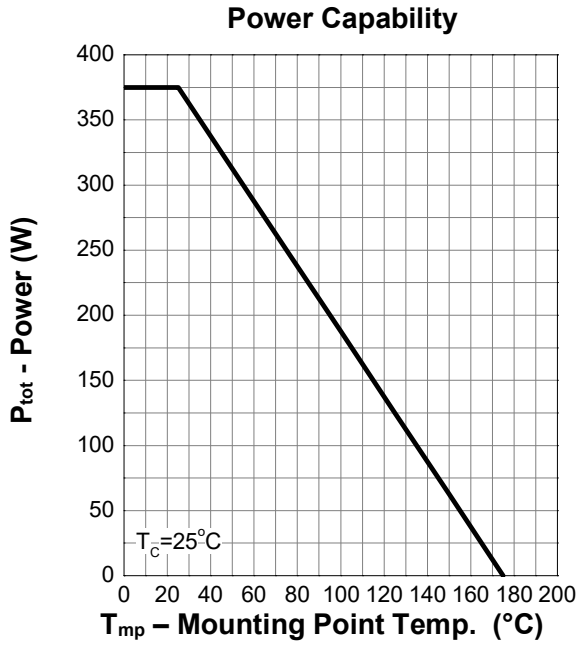
## 6. Electrical Characteristics (T<sub>A</sub> = 25 °C Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	120	-	-	V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>DS</sub> = 250 μA	2	-	4	V
I <sub>DSS</sub>	Zero Gate Voltage Source Current	V <sub>DS</sub> = 96 V, V <sub>GS</sub> = 0 V	-	-	1	μA
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> = ± 20 V, V <sub>DS</sub> = 0 V	-	-	± 100	nA
R <sub>DS(ON)</sub> <sup>a</sup>	Drain-Source On-State Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	5.0	5.5	mΩ
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 10 A	-	6.5	7.5	
<b>Diode Characteristics</b>						
V <sub>SD</sub> <sup>a</sup>	Diode Forward Voltage	I <sub>SD</sub> = 20 A, V <sub>GS</sub> = 0 V	-	-	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>SD</sub> = 20 A, dI <sub>SD</sub> /dt = 100 A/μs	-	92	-	nS
Q <sub>rr</sub>	Reverse Recovery Charge		-	337	-	nC
<b>Dynamic Characteristics<sup>b</sup></b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 60 V Frequency = 1 MHz	-	4779	-	pF
C <sub>oss</sub>	Output Capacitance		-	570	-	
C <sub>rss</sub>	Reverse Transfer Capacitance		-	34	-	
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DS</sub> = 60 V, V <sub>GEN</sub> = 10 V, R <sub>G</sub> = 3.9 Ω, R <sub>L</sub> = 3 Ω, I <sub>DS</sub> = 20 A	-	16	-	nS
t <sub>r</sub>	Turn-on Rise Time		-	27	-	
t <sub>d(off)</sub>	Turn-off Delay Time		-	51	-	
t <sub>f</sub>	Turn-off Fall Time		-	27	-	
<b>Gate Charge Characteristics<sup>b</sup></b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 10 V, I <sub>DS</sub> = 20 A	-	80	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	24	-	
Q <sub>gd</sub>	Gate-Drain Charge		-	18	-	

Notes :

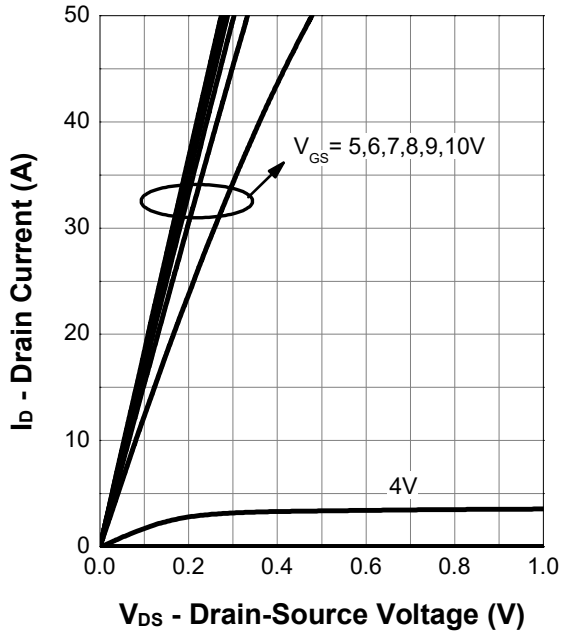
- a : Pulse test ; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- b : Guaranteed by design, not subject to production testing

### 7. Typical Characteristics (Cont.)

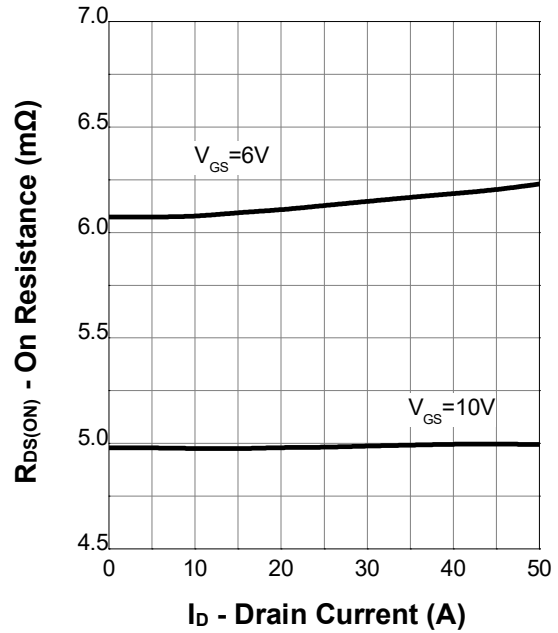


### 7. Typical Characteristics (Cont.)

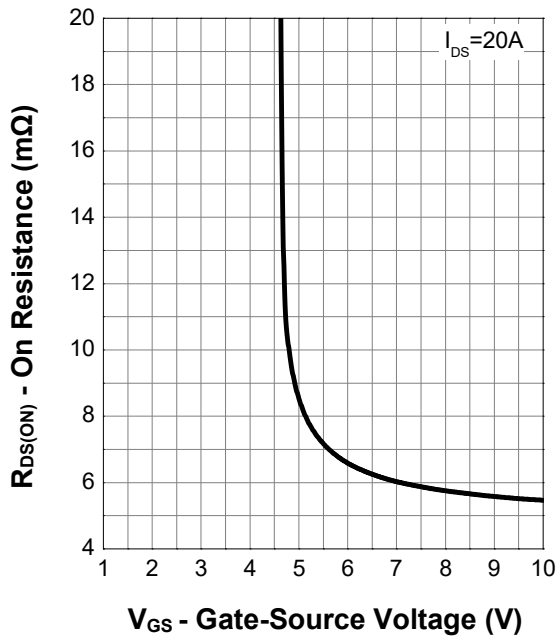
Output Characteristics



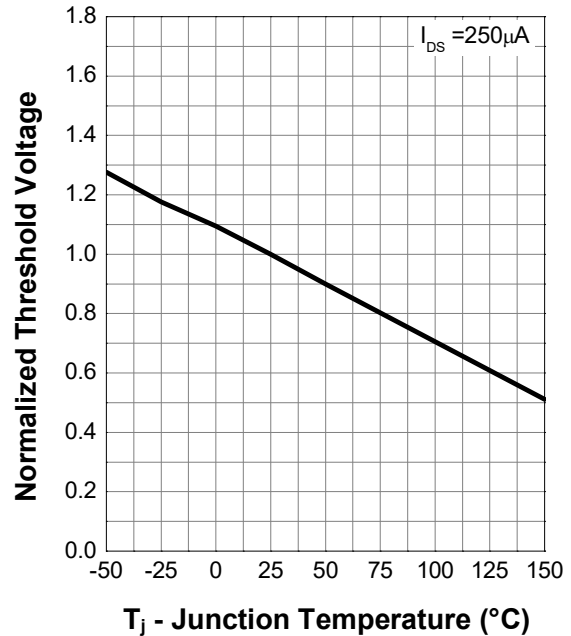
On Resistance



Transfer Characteristics

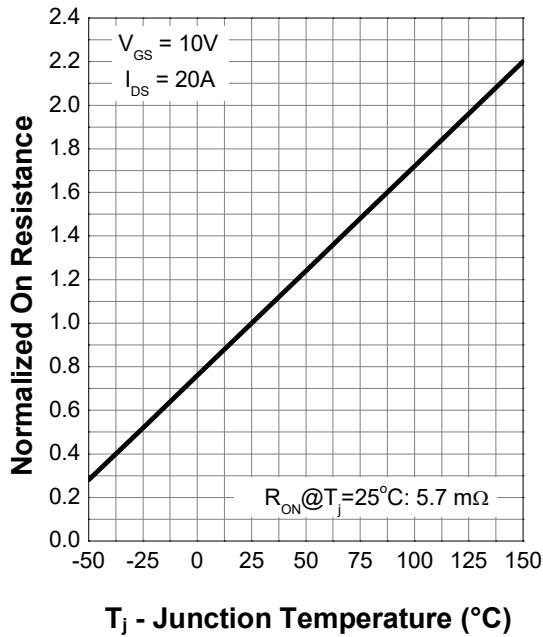


Normalized Threshold Voltage

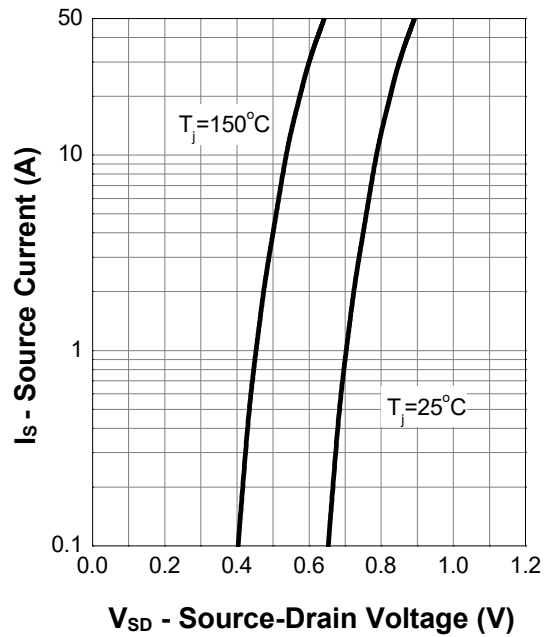


### 7. Typical Characteristics (Cont.)

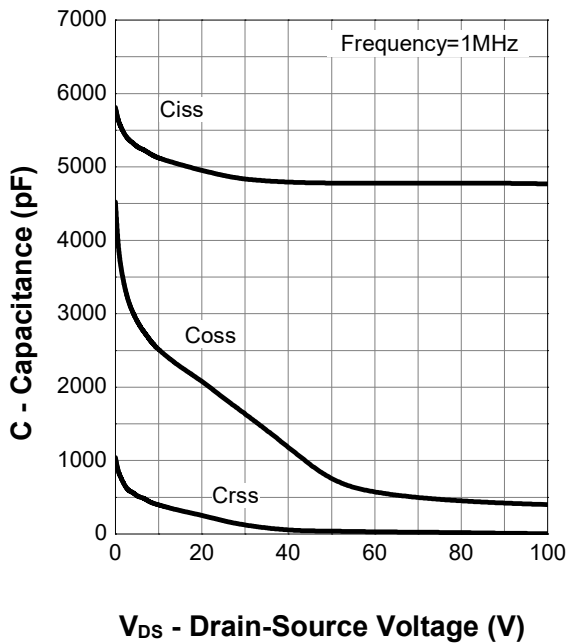
**Normalized On Resistance**



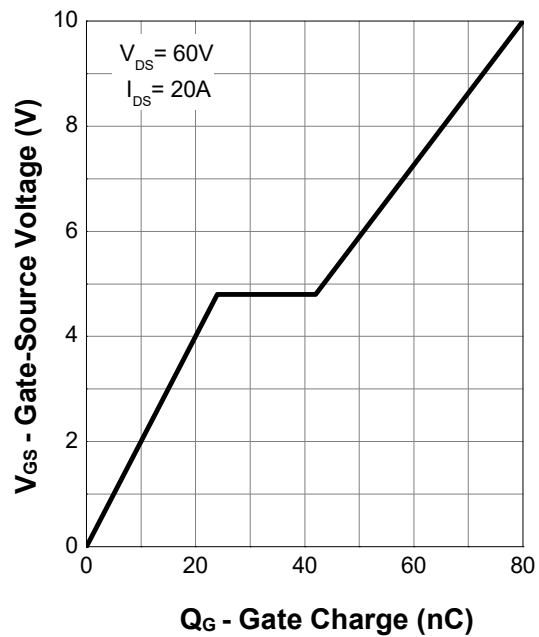
**Diode Forward Current**



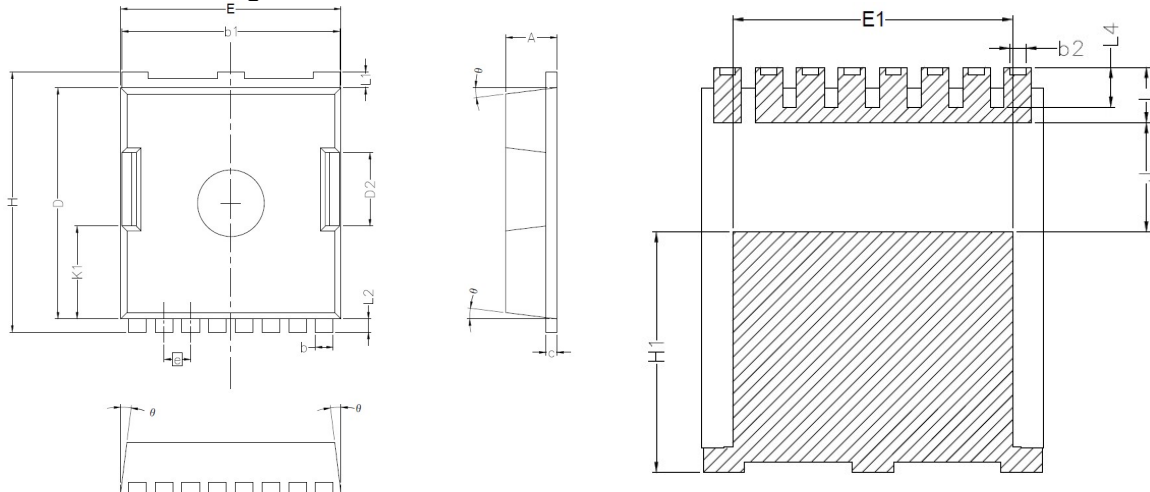
**Capacitance**



**Gate Charge**



## 8. Package Dimensions

**TOLL-8L Package**


Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	2.20	2.40
b	0.70	0.90
b1	9.70	9.90
b2	0.42	0.50
c	0.40	0.60
D	10.28	10.58
D2	3.10	3.50
E	9.70	10.10
E1	7.90	8.30
e	1.20BSC	
H	11.48	11.88
H1	6.75	7.15
N	8	
J	3.00	3.30
K1	3.98	4.38
L	1.40	1.80
L1	0.60	0.80
L2	0.50	0.70
L4	1.00	1.30
$\theta$	4°	10°